

High speed switching series fifth generation

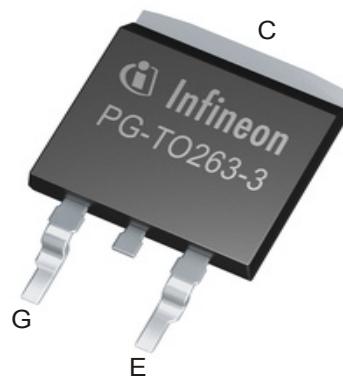
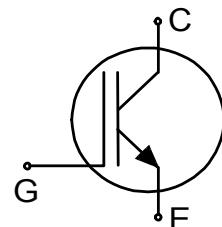
High speed IGBT in TRENCHSTOP™ 5 technology

Features and Benefits:

- High speed H5 technology offering:
- Best-in-Class efficiency in hard switching and resonant topologies
- Plug and play replacement of previous generation IGBTs
- 650V breakdown voltage
- Low gate charge Q_G
- Maximum junction temperature 175°C
- Dynamically stress tested
- Qualified according to AEC-Q101
- Green package (RoHS compliant)
- Complete product spectrum and PSpice Models:
<http://www.infineon.com/igbt/>

Applications:

- Off-board charger
- On-board charger
- DC/DC converter
- Power-Factor correction



Package pin definition:

- Pin 1 - gate
- Pin 2 & backside - collector
- Pin 3 - emitter



Key Performance and Package Parameters

| Type | V_{CE} | I_C | $V_{CEsat}, T_{vj}=25^\circ\text{C}$ | T_{vjmax} | Marking | Package |
|-------------|----------|-------|--------------------------------------|-------------|---------|------------|
| AIGB40N65H5 | 650V | 40A | 1.65V | 175°C | AG40EH5 | PG-T0263-3 |

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Maximum Ratings

| Parameter | Symbol | Value | Unit |
|--|-------------|----------------------|------|
| Collector-emitter voltage, $T_{vj} \geq 25^\circ\text{C}$ | V_{CE} | 650 | V |
| DC collector current, limited by T_{vjmax} $T_c = 25^\circ\text{C}$ $T_c = 100^\circ\text{C}$ | I_C | 74.0 46.0 | A |
| Pulsed collector current, t_p limited by T_{vjmax} ¹⁾ | I_{Cpuls} | 120.0 | A |
| Turn off safe operating area $V_{CE} \leq 650\text{V}$, $T_{vj} \leq 175^\circ\text{C}$, $t_p = 1\mu\text{s}$ ¹⁾ | - | 120.0 | A |
| Gate-emitter voltage Transient Gate-emitter voltage ($t_p \leq 10\mu\text{s}$, $D < 0.010$) | V_{GE} | ± 20 ± 30 | V |
| Power dissipation $T_c = 25^\circ\text{C}$ Power dissipation $T_c = 100^\circ\text{C}$ | P_{tot} | 250.0 125.0 | W |
| Operating junction temperature | T_{vj} | -40...+175 | °C |
| Storage temperature | T_{stg} | -55...+150 | °C |
| Soldering temperature, reflow soldering (MSL1 according to JEDEC J-STA-020) | | 260 | °C |

Thermal Resistance

| Parameter | Symbol | Conditions | Value | | | Unit |
|---|---------------|------------|-------|------|------|------|
| | | | min. | typ. | max. | |
| R_{th} Characteristics | | | | | | |
| IGBT thermal resistance, junction - case | $R_{th(j-c)}$ | | - | - | 0.60 | K/W |
| Thermal resistance, min. footprint junction - ambient | $R_{th(j-a)}$ | | - | - | 65 | K/W |
| Thermal resistance, 6cm ² Cu on PCB junction - ambient | $R_{th(j-a)}$ | | - | - | 40 | K/W |

Electrical Characteristic, at $T_{vj} = 25^\circ\text{C}$, unless otherwise specified

| Parameter | Symbol | Conditions | Value | | | Unit |
|--------------------------------------|---------------|---|-------|----------------------|----------------|------|
| | | | min. | typ. | max. | |
| Static Characteristic | | | | | | |
| Collector-emitter breakdown voltage | $V_{(BR)CES}$ | $V_{GE} = 0\text{V}$, $I_C = 0.20\text{mA}$ | 650 | - | - | V |
| Collector-emitter saturation voltage | V_{CESat} | $V_{GE} = 15.0\text{V}$, $I_C = 40.0\text{A}$ $T_{vj} = 25^\circ\text{C}$ $T_{vj} = 125^\circ\text{C}$ $T_{vj} = 175^\circ\text{C}$ | - | 1.65 1.85 1.95 | 2.10 - - | V |
| Gate-emitter threshold voltage | $V_{GE(th)}$ | $I_C = 0.40\text{mA}$, $V_{CE} = V_{GE}$ | 3.2 | 4.0 | 4.8 | V |
| Zero gate voltage collector current | I_{CES} | $V_{CE} = 650\text{V}$, $V_{GE} = 0\text{V}$ $T_{vj} = 25^\circ\text{C}$ $T_{vj} = 175^\circ\text{C}$ | - | - 1000 | 40 - | μA |
| Gate-emitter leakage current | I_{GES} | $V_{CE} = 0\text{V}$, $V_{GE} = 20\text{V}$ | - | - | 100 | nA |
| Transconductance | g_{fs} | $V_{CE} = 20\text{V}$, $I_C = 40.0\text{A}$ | - | 40.0 | - | S |

¹⁾ Defined by design. Not subject to production test.

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Electrical Characteristic, at $T_{vj} = 25^\circ\text{C}$, unless otherwise specified

| Parameter | Symbol | Conditions | Value | | | Unit |
|--|-----------|---|-------|------|------|------|
| | | | min. | typ. | max. | |
| Dynamic Characteristic | | | | | | |
| Input capacitance | C_{ies} | $V_{CE} = 25\text{V}, V_{GE} = 0\text{V}, f = 1\text{MHz}$ | - | 2500 | - | pF |
| Output capacitance | C_{oes} | | - | 50 | - | |
| Reverse transfer capacitance | C_{res} | | - | 9 | - | |
| Gate charge | Q_G | $V_{CC} = 520\text{V}, I_C = 40.0\text{A}, V_{GE} = 15\text{V}$ | - | 90.0 | - | nC |
| Internal emitter inductance measured 5mm (0.197 in.) from case | L_E | | - | 7.0 | - | nH |

Switching Characteristic, Inductive Load

| Parameter | Symbol | Conditions | Value | | | Unit |
|---|--------------|---|-------|------|------|------|
| | | | min. | typ. | max. | |
| IGBT Characteristic, at $T_{vj} = 25^\circ\text{C}$ | | | | | | |
| Turn-on delay time | $t_{d(on)}$ | $T_{vj} = 25^\circ\text{C}, V_{CC} = 400\text{V}, I_C = 20.0\text{A}, V_{GE} = 0.0/15.0\text{V}, R_{G(on)} = 15.0\Omega, R_{G(off)} = 15.0\Omega, L_\sigma = 30\text{nH}, C_\sigma = 30\text{pF}$ L_σ, C_σ from Fig. E Energy losses include "tail" and diode reverse recovery. | - | 21 | - | ns |
| Rise time | t_r | | - | 21 | - | ns |
| Turn-off delay time | $t_{d(off)}$ | | - | 158 | - | ns |
| Fall time | t_f | | - | 15 | - | ns |
| Turn-on energy | E_{on} | | - | 0.41 | - | mJ |
| Turn-off energy | E_{off} | | - | 0.12 | - | mJ |
| Total switching energy | E_{ts} | | - | 0.53 | - | mJ |
| Turn-on delay time | $t_{d(on)}$ | $T_{vj} = 25^\circ\text{C}, V_{CC} = 400\text{V}, I_C = 5.0\text{A}, V_{GE} = 0.0/15.0\text{V}, R_{G(on)} = 15.0\Omega, R_{G(off)} = 15.0\Omega, L_\sigma = 30\text{nH}, C_\sigma = 30\text{pF}$ L_σ, C_σ from Fig. E Energy losses include "tail" and diode reverse recovery. | - | 19 | - | ns |
| Rise time | t_r | | - | 5 | - | ns |
| Turn-off delay time | $t_{d(off)}$ | | - | 163 | - | ns |
| Fall time | t_f | | - | 37 | - | ns |
| Turn-on energy | E_{on} | | - | 0.11 | - | mJ |
| Turn-off energy | E_{off} | | - | 0.05 | - | mJ |
| Total switching energy | E_{ts} | | - | 0.16 | - | mJ |

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Switching Characteristic, Inductive Load

| Parameter | Symbol | Conditions | Value | | | Unit |
|--|--------------|--|-------|------|------|------|
| | | | min. | typ. | max. | |
| IGBT Characteristic, at $T_{vj} = 150^{\circ}\text{C}$ | | | | | | |
| Turn-on delay time | $t_{d(on)}$ | $T_{vj} = 150^{\circ}\text{C}$, $V_{CC} = 400\text{V}$, $I_C = 20.0\text{A}$, $V_{GE} = 0.0/15.0\text{V}$, | - | 21 | - | ns |
| Rise time | t_r | $R_{G(on)} = 15.0\Omega$, $R_{G(off)} = 15.0\Omega$, $L\sigma = 30\text{nH}$, $C\sigma = 30\text{pF}$ | - | 15 | - | ns |
| Turn-off delay time | $t_{d(off)}$ | $L\sigma$, $C\sigma$ from Fig. E | - | 176 | - | ns |
| Fall time | t_f | Energy losses include "tail" and diode reverse recovery. | - | 20 | - | ns |
| Turn-on energy | E_{on} | | - | 0.54 | - | mJ |
| Turn-off energy | E_{off} | | - | 0.18 | - | mJ |
| Total switching energy | E_{ts} | | - | 0.72 | - | mJ |
| | | | | | | |
| Turn-on delay time | $t_{d(on)}$ | $T_{vj} = 150^{\circ}\text{C}$, $V_{CC} = 400\text{V}$, $I_C = 5.0\text{A}$, $V_{GE} = 0.0/15.0\text{V}$, | - | 18 | - | ns |
| Rise time | t_r | $R_{G(on)} = 15.0\Omega$, $R_{G(off)} = 15.0\Omega$, $L\sigma = 30\text{nH}$, $C\sigma = 30\text{pF}$ | - | 6 | - | ns |
| Turn-off delay time | $t_{d(off)}$ | $L\sigma$, $C\sigma$ from Fig. E | - | 196 | - | ns |
| Fall time | t_f | Energy losses include "tail" and diode reverse recovery. | - | 32 | - | ns |
| Turn-on energy | E_{on} | | - | 0.17 | - | mJ |
| Turn-off energy | E_{off} | | - | 0.06 | - | mJ |
| Total switching energy | E_{ts} | | - | 0.23 | - | mJ |

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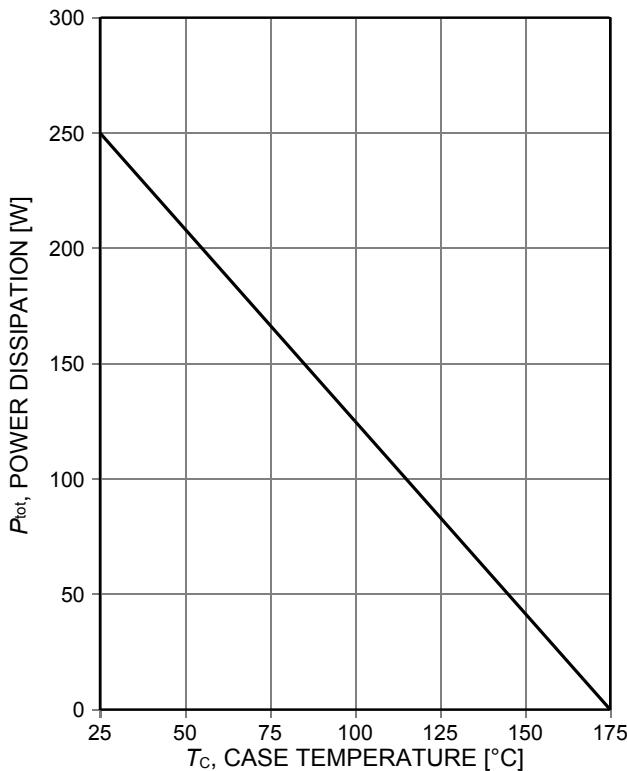


Figure 1. Power dissipation as a function of case temperature
($T_{vj} \leq 175^\circ\text{C}$)

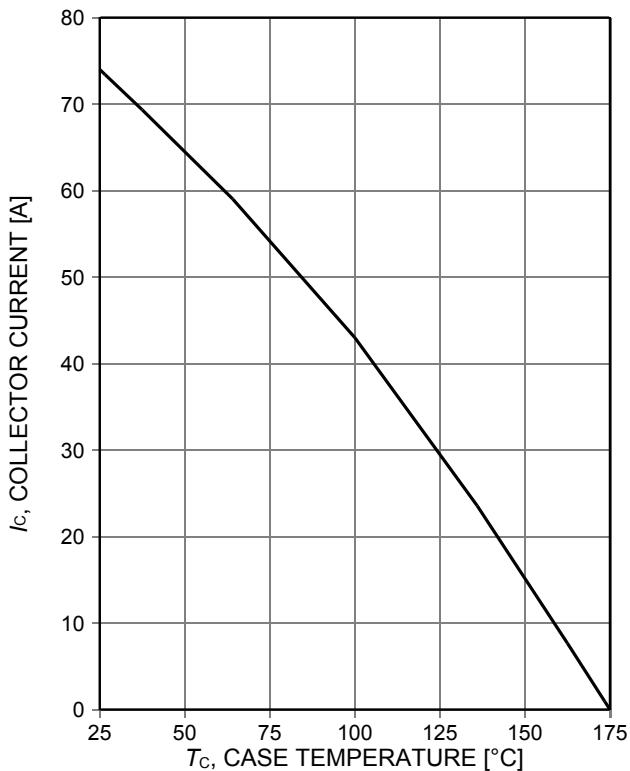


Figure 2. Collector current as a function of case temperature
($V_{GE} \geq 15\text{V}$, $T_{vj} \leq 175^\circ\text{C}$)

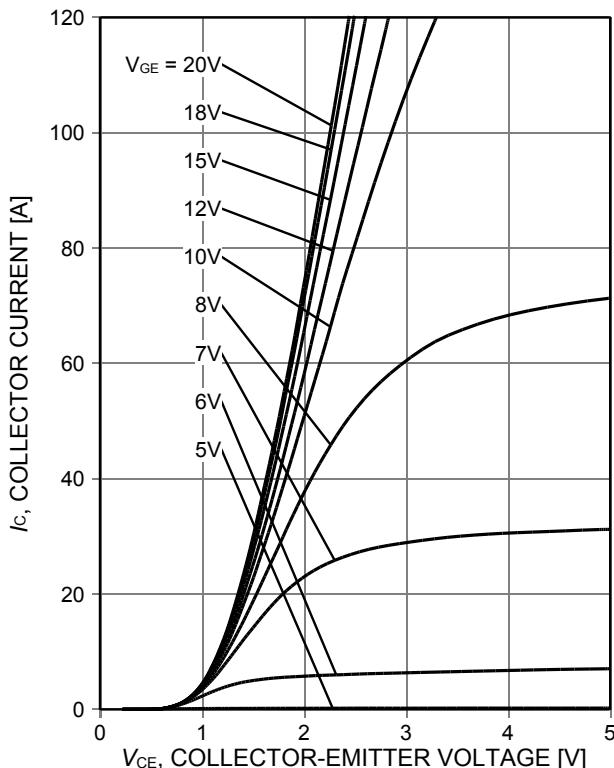


Figure 3. Typical output characteristic
($T_{vj}=25^\circ\text{C}$)

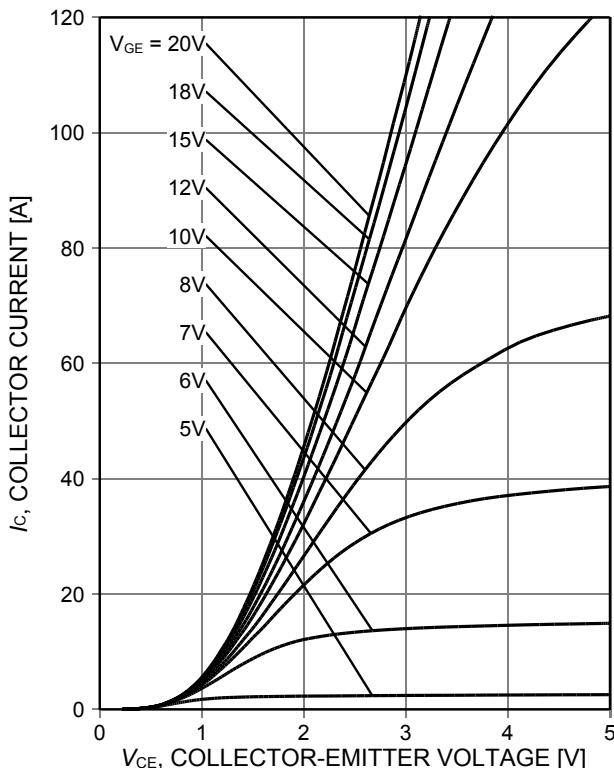


Figure 4. Typical output characteristic
($T_{vj}=150^\circ\text{C}$)

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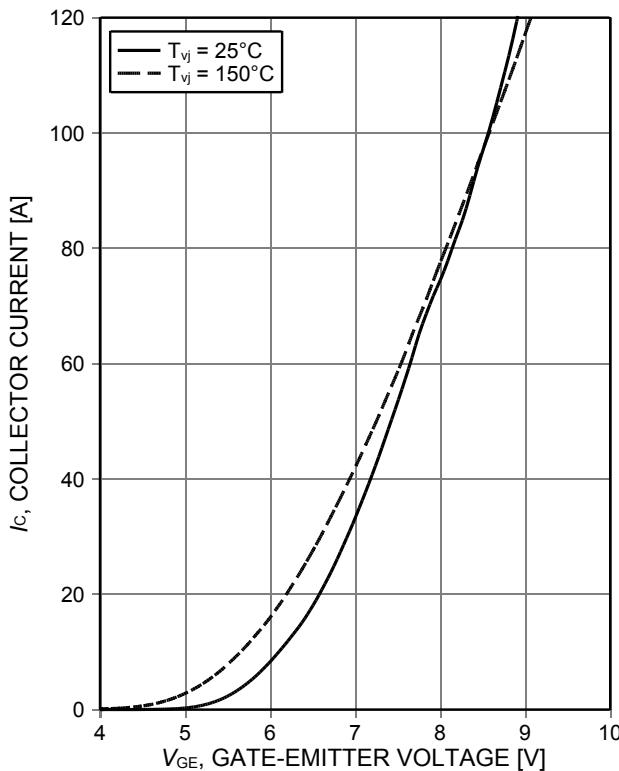


Figure 5. Typical transfer characteristic
($V_{CE}=20V$)

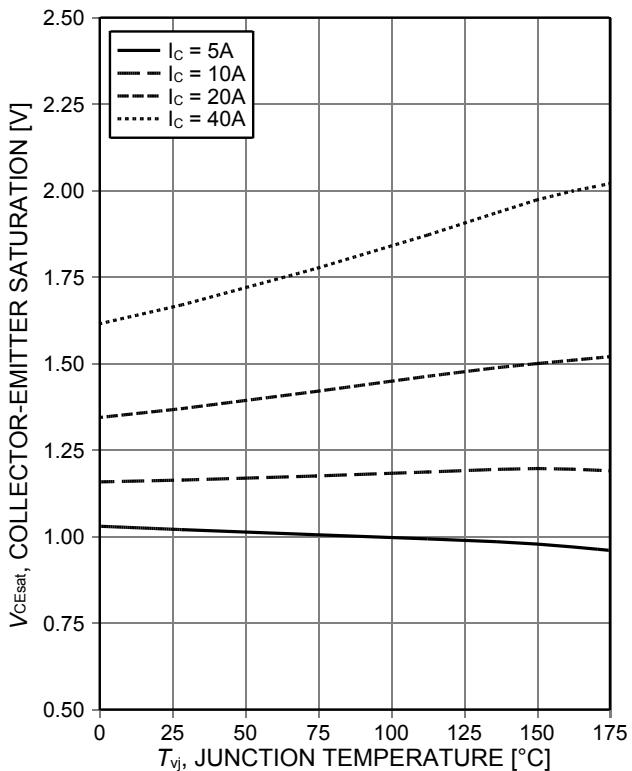


Figure 6. Typical collector-emitter saturation voltage as a function of junction temperature
($V_{GE}=15V$)

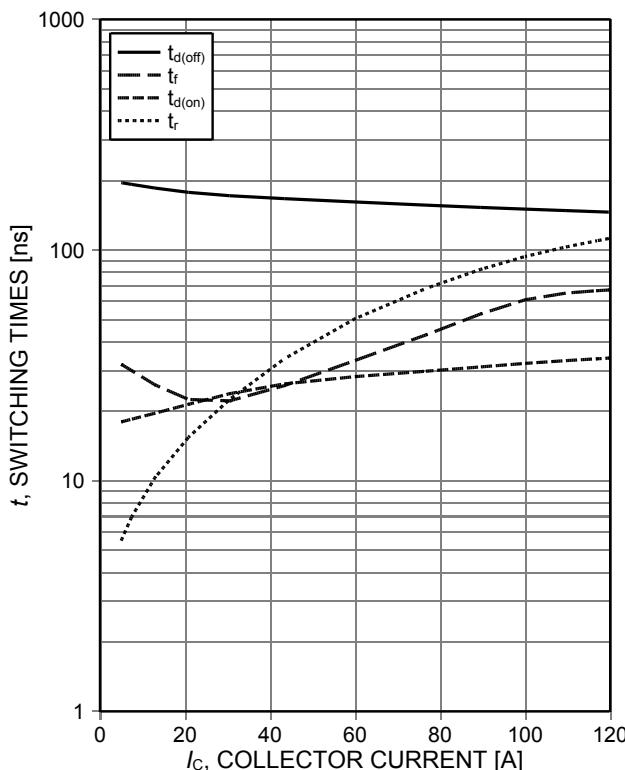


Figure 7. Typical switching times as a function of collector current
(inductive load, $T_{vj}=150^{\circ}C$, $V_{CE}=400V$,
 $V_{GE}=15/0V$, $r_G=15\Omega$, Dynamic test circuit in
Figure E)

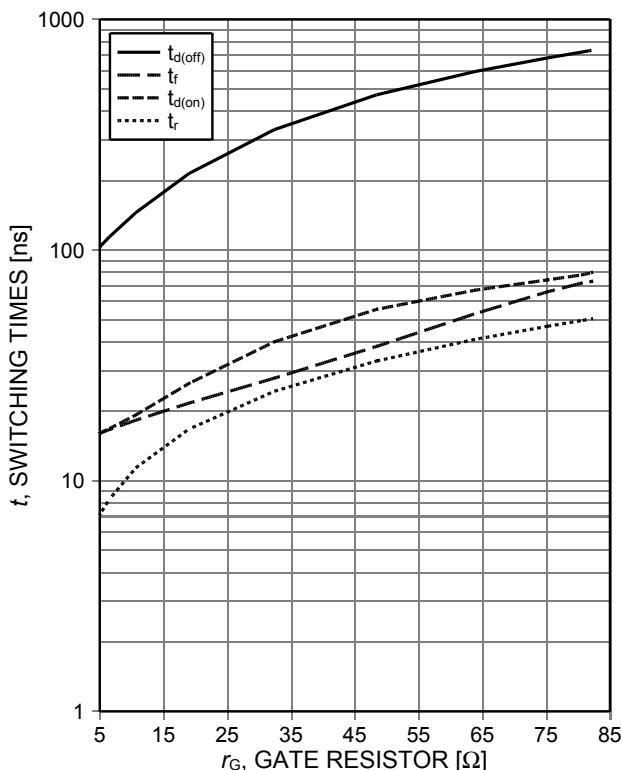


Figure 8. Typical switching times as a function of gate resistor
(inductive load, $T_{vj}=150^{\circ}C$, $V_{CE}=400V$,
 $V_{GE}=15/0V$, $I_c=20A$, Dynamic test circuit in
Figure E)

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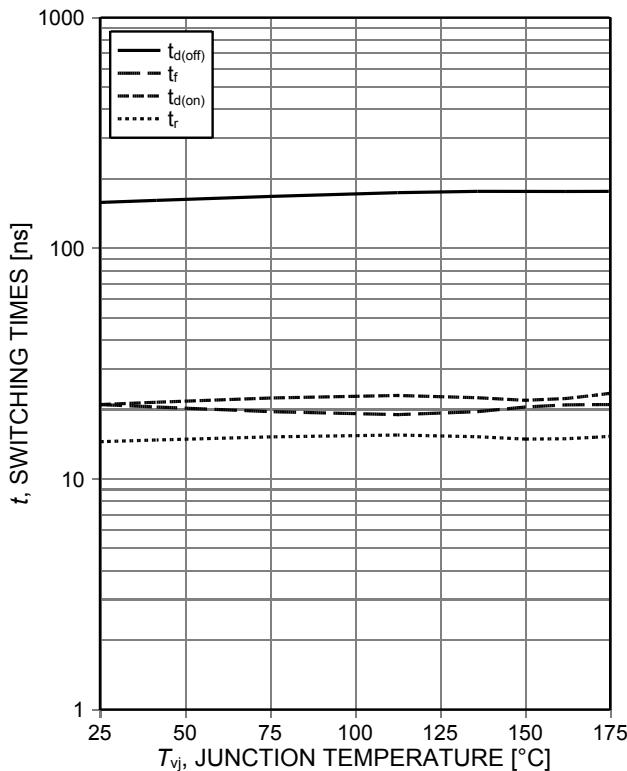


Figure 9. **Typical switching times as a function of junction temperature**
(inductive load, $V_{CE}=400V$, $V_{GE}=15/0V$, $I_C=20A$, $r_G=15\Omega$, Dynamic test circuit in Figure E)

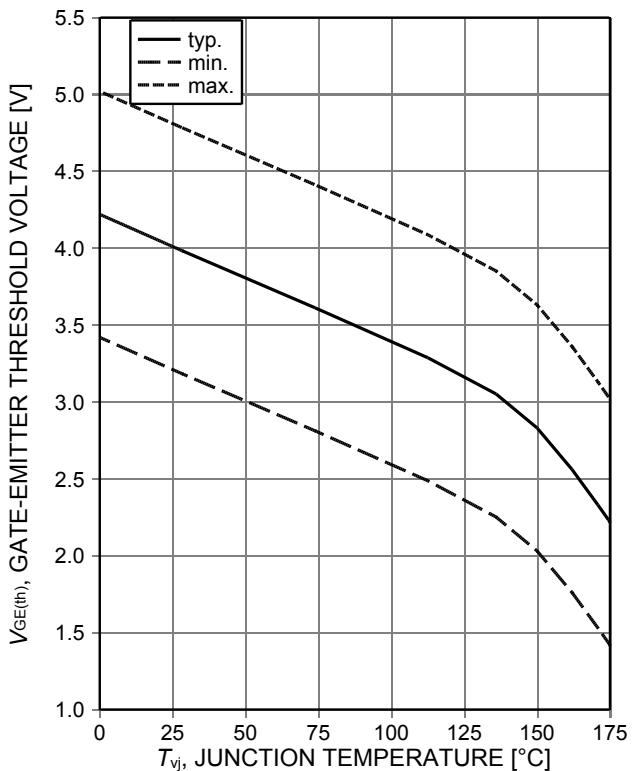


Figure 10. **Gate-emitter threshold voltage as a function of junction temperature**
($I_C=0.4mA$)

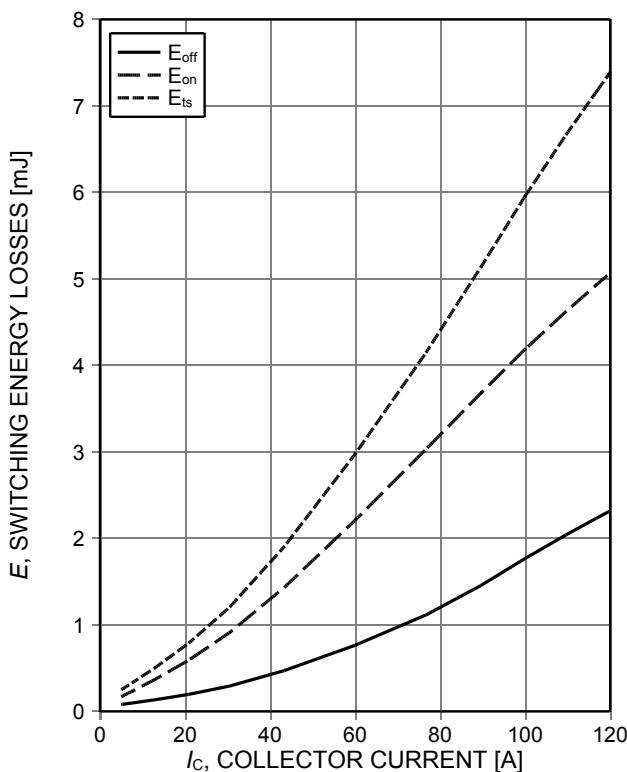


Figure 11. **Typical switching energy losses as a function of collector current**
(inductive load, $T_{vj}=150^{\circ}C$, $V_{CE}=400V$, $V_{GE}=15/0V$, $r_G=15\Omega$, Dynamic test circuit in Figure E)

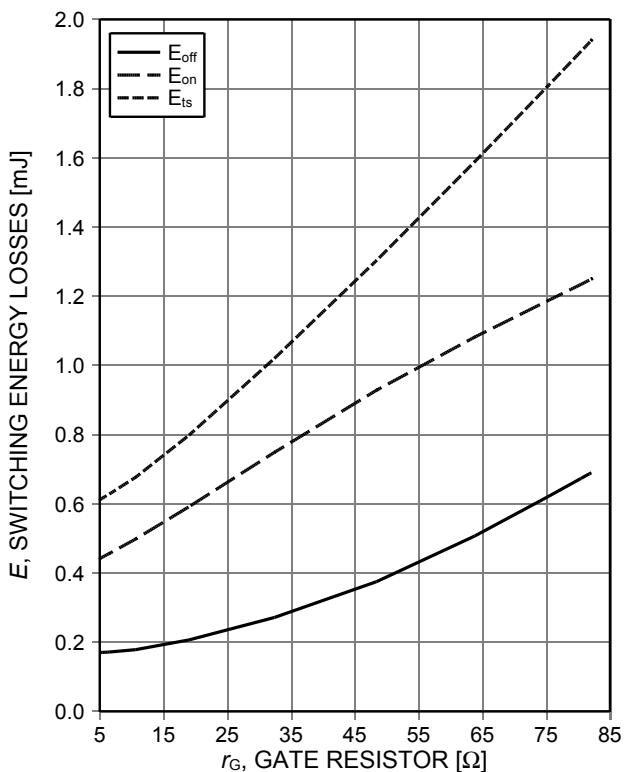


Figure 12. **Typical switching energy losses as a function of gate resistor**
(inductive load, $T_{vj}=150^{\circ}C$, $V_{CE}=400V$, $V_{GE}=15/0V$, $I_C=20A$, Dynamic test circuit in Figure E)

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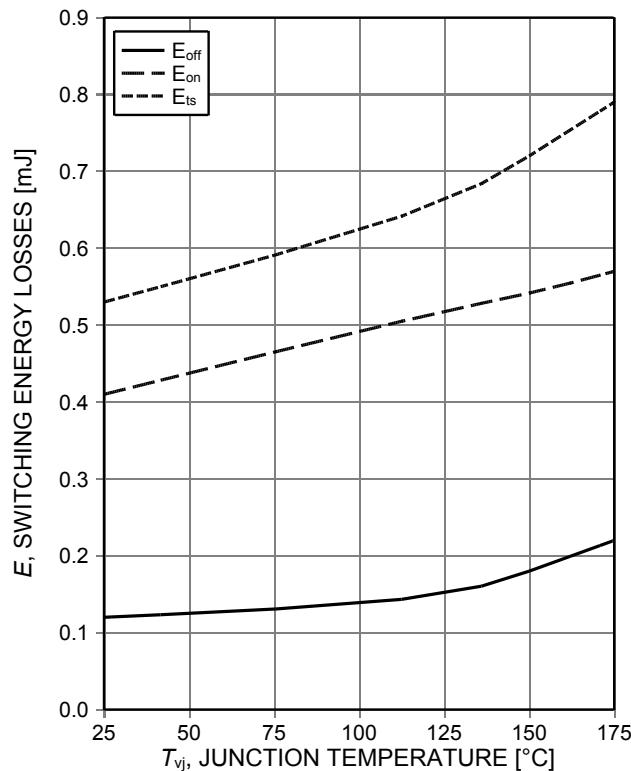


Figure 13. **Typical switching energy losses as a function of junction temperature**
(inductive load, $V_{CE}=400V$, $V_{GE}=15/0V$, $I_C=20A$, $r_G=15\Omega$, Dynamic test circuit in Figure E)

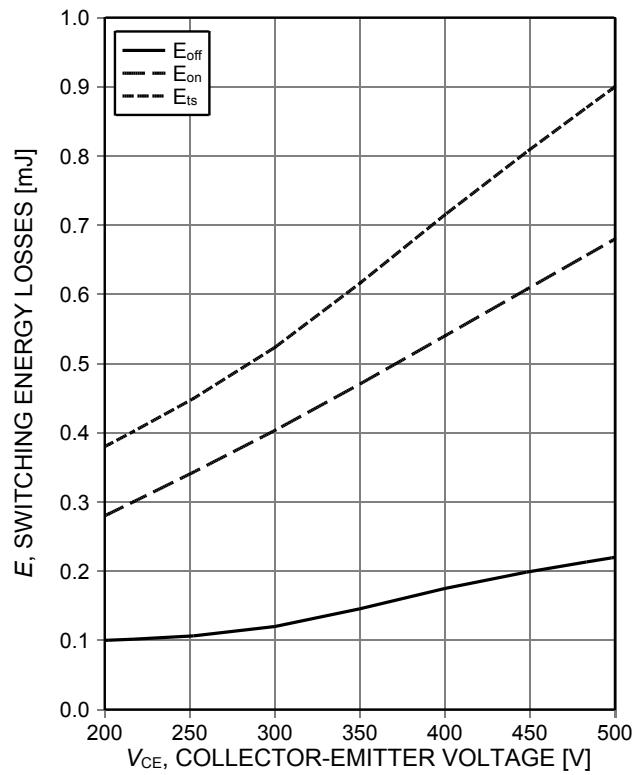


Figure 14. **Typical switching energy losses as a function of collector-emitter voltage**
(inductive load, $T_{vj}=150^{\circ}C$, $V_{GE}=15/0V$, $I_C=20A$, $r_G=15\Omega$, Dynamic test circuit in Figure E)

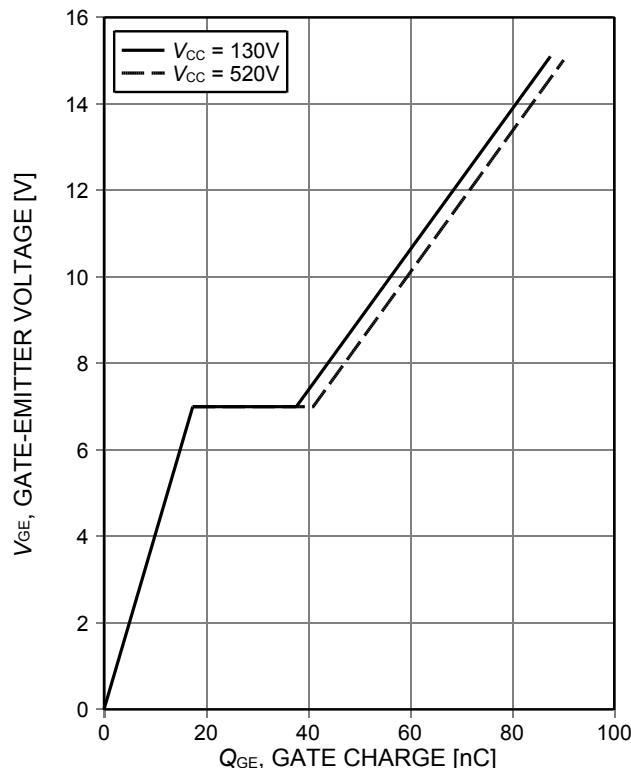


Figure 15. **Typical gate charge**
($I_C=40A$)

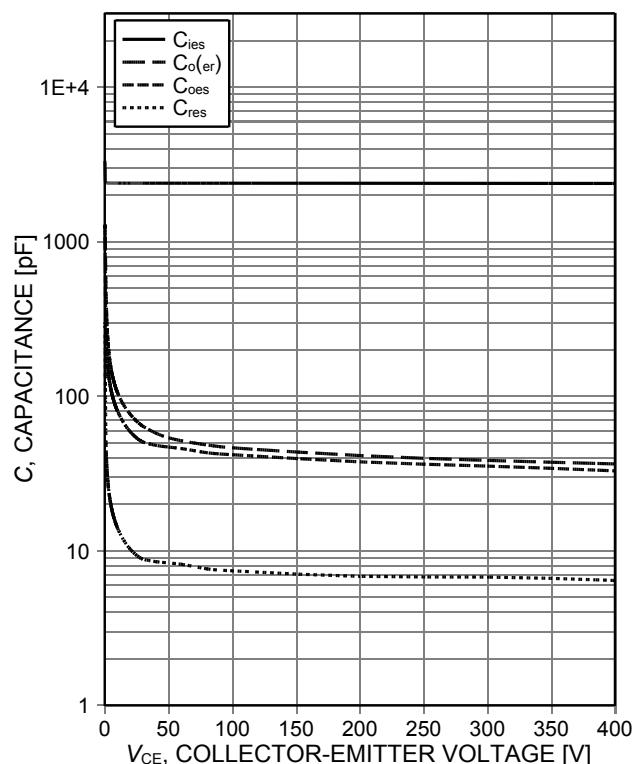


Figure 16. **Typical capacitance as a function of collector-emitter voltage**
($V_{GE}=0V$, $f=1MHz$)

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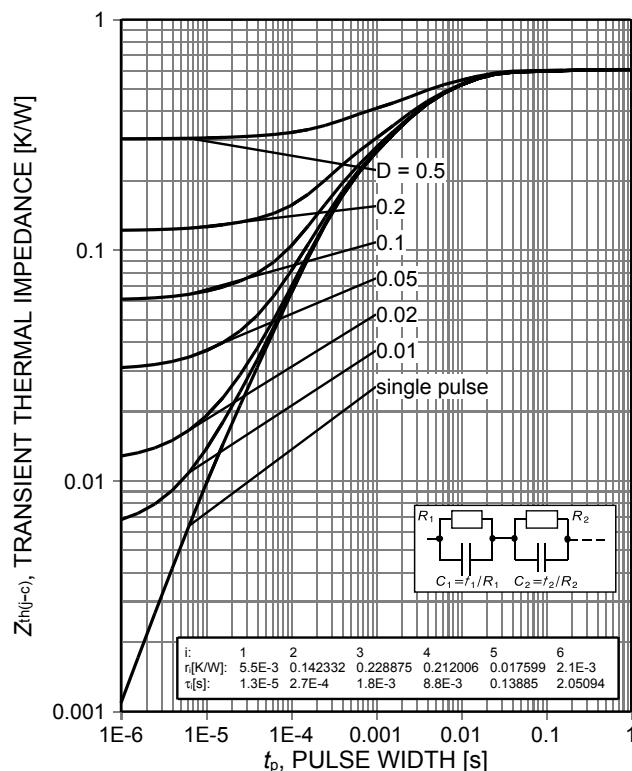
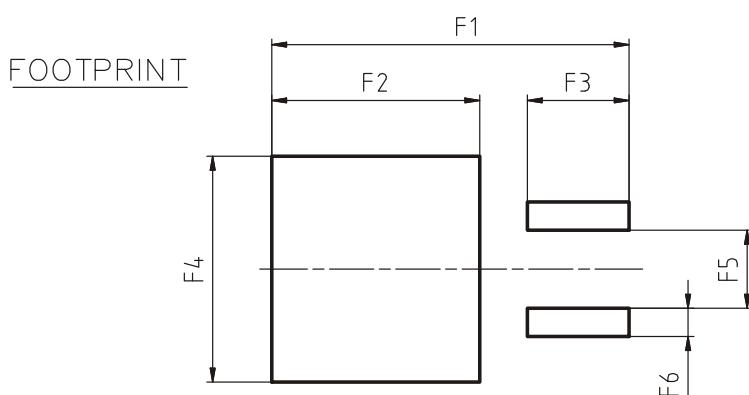
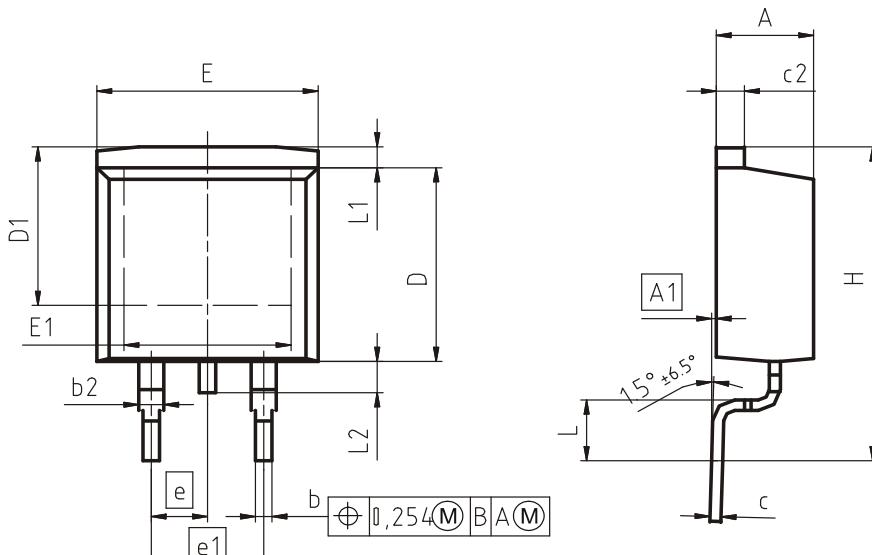


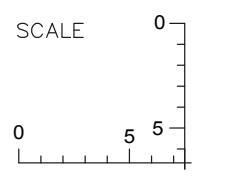
Figure 17. IGBT transient thermal impedance
($D=t_p/T$)

High speed switching series fifth generation

Package Drawing PG-TO263-3



| DIM | MILLIMETERS | | INCHES | |
|-----|-------------|-------|--------|-------|
| | MIN | MAX | MIN | MAX |
| A | 4.30 | 4.57 | 0.169 | 0.180 |
| A1 | 0.00 | 0.25 | 0.000 | 0.010 |
| b | 0.65 | 0.85 | 0.026 | 0.033 |
| b2 | 0.95 | 1.15 | 0.037 | 0.045 |
| c | 0.33 | 0.65 | 0.013 | 0.026 |
| c2 | 1.17 | 1.40 | 0.046 | 0.055 |
| D | 8.51 | 9.45 | 0.335 | 0.372 |
| D1 | 7.10 | 7.90 | 0.280 | 0.311 |
| E | 9.80 | 10.31 | 0.386 | 0.406 |
| E1 | 6.50 | 8.60 | 0.256 | 0.339 |
| e | 2.54 | | 0.100 | |
| e1 | 5.08 | | 0.200 | |
| N | 2 | | 2 | |
| H | 14.61 | 15.88 | 0.575 | 0.625 |
| L | 2.29 | 3.00 | 0.090 | 0.118 |
| L1 | 0.70 | 1.60 | 0.028 | 0.063 |
| L2 | 1.00 | 1.78 | 0.039 | 0.070 |
| F1 | 16.05 | 16.25 | 0.632 | 0.640 |
| F2 | 9.30 | 9.50 | 0.366 | 0.374 |
| F3 | 4.50 | 4.70 | 0.177 | 0.185 |
| F4 | 10.70 | 10.90 | 0.421 | 0.429 |
| F5 | 3.65 | 3.85 | 0.144 | 0.152 |
| F6 | 1.25 | 1.45 | 0.049 | 0.057 |

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EUROPEAN PROJECTION

ISSUE DATE
30-08-2007REVISION
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High speed switching series fifth generation

Testing Conditions

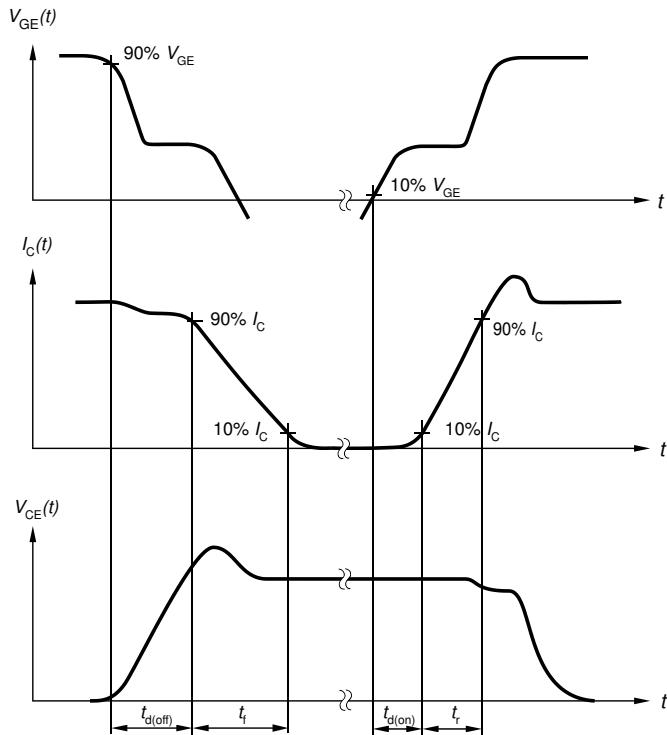


Figure A. Definition of switching times

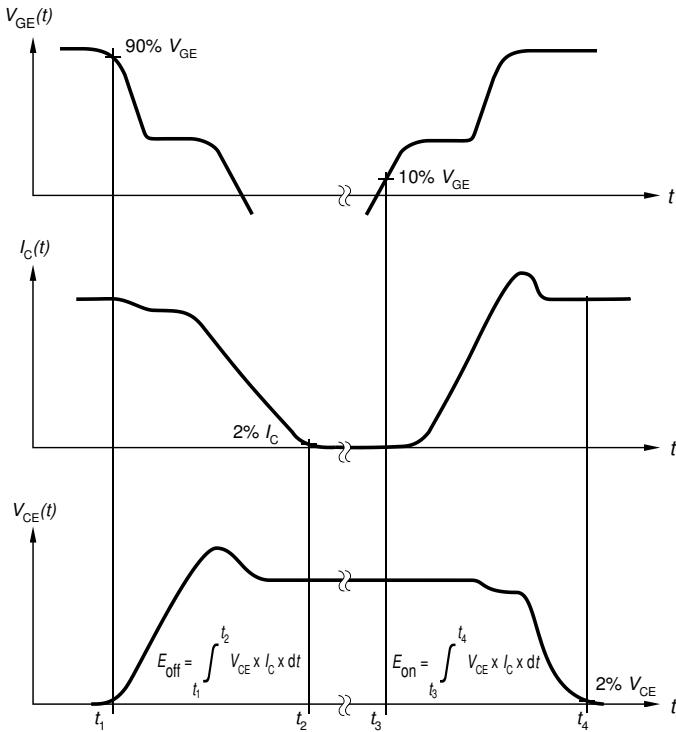


Figure B. Definition of switching losses

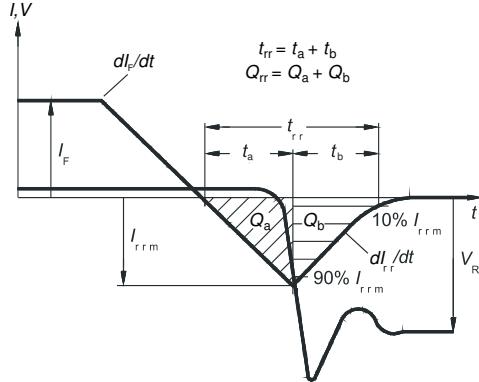


Figure C. Definition of diode switching characteristics

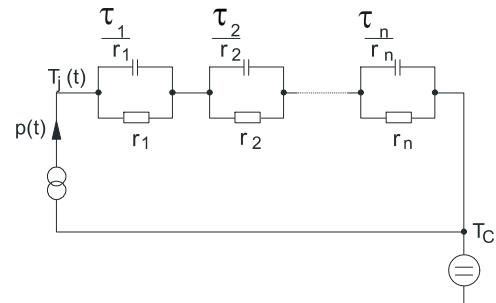


Figure D. Thermal equivalent circuit

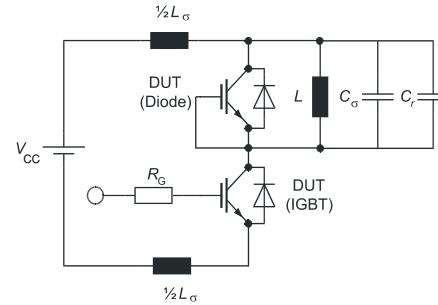


Figure E. Dynamic test circuit
 Parasitic inductance L_σ ,
 parasitic capacitor C_σ ,
 relief capacitor C_r ,
 (only for ZVT switching)

High speed switching series fifth generation**Revision History**

AIGB40N65H5

Revision: 2019-10-19, Rev. 2.1

Previous Revision

| Revision | Date | Subjects (major changes since last revision) |
|----------|------------|--|
| 2.1 | 2019-10-19 | Final Datasheet |